WeEn WeEns

WNSC2D16650CW

Silicon Carbide Diode

Rev.01 - 11 March 2021

Product data sheet

1. General description

Dual Silicon Carbide Schottky diode in a 3-lead TO247 plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- Highly stable switching performance
- · Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant

3. Applications

- Power factor correction
 - Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Q	uick reference data							
Symbol	Parameter Conditions			Values			Unit	
Absolute	maximum rating							
V_{RRM}	repetitive peak reverse voltage		650			V		
I _{O(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 124 °C; both diodes conducting; Fig. 1; Fig. 2; Fig. 3	16			A		
T _j	junction temperature		175		°C			
Symbol	Parameter	Conditions	Min Typ Max		Unit			
Static ch	Static characteristics							
V _F forward voltage		$I_F = 8 \text{ A}; T_j = 25 \text{ °C}; \text{ per diode}; Fig. 5$		-	1.5	1.7	V	
		$I_{F} = 8 \text{ A}; T_{j} = 150 \text{ °C}; \text{ per diode}; Fig. 5$		-	1.8	2.2	V	
Dynamic	Dynamic characteristics							
Q _r	$ \begin{array}{c c} \mbox{recovered charge} & I_{F} = 8 \mbox{ A; } dI_{F}/dt = 500 \mbox{ A}/\mu \mbox{s; } V_{R} = 400 \mbox{ V; } & - & 13 & - \\ T_{j} = 25 \mbox{ °C; per diode; } \underline{Fig. 7} & & \end{array} $		-	nC				

5. Pinning information

Table 2. P	Table 2. Pinning information					
Pin	Symbol	Description	Simplified outline	Graphic symbol		
1	A1	anode				
2	К	cathode				
3	A2	anode		<u> </u>		
mb	mb	mounting base; connected to cathode		sym125		

6. Ordering information

Table 3. Ordering information							
Type number	Package	Orderable part number	J	Small packing	Package	Package	
	name		method	quantity	version	issue date	
WNSC2D16650CW	TO247	WNSC2D16650CWQ	Tube	30	TO247N	20-July-2016	

7. Marking

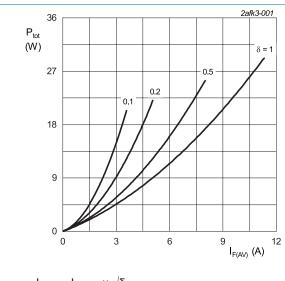
Table 4. Marking codes						
Type number	Marking codes					
WNSC2D16650CW	WNSC2D 16650CW					

8. Limiting values

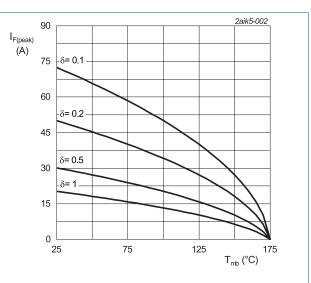
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V _{RRM}	repetitive peak reverse voltage		650	V
V_{RWM}	crest working reverse voltage		650	V
V _R	reverse voltage	DC	650	V
I _{O(AV)}	average forward current	δ = 0.5; square-wave pulse; T _{mb} ≤ 124 °C; both diodes conducting; <u>Fig. 1</u> ; <u>Fig. 2</u> ; <u>Fig. 3</u>	16	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 µs; T _{mb} ≤ 124 °C; square-wave pulse; per diode	16	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	48	A
		t_p = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse; per diode	385	A
l ² t	l ² t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; t_p = 10 ms	11.5	A²s
T _{stg}	storage temperature		-55 to 175	°C
T _j	junction temperature		175	°C

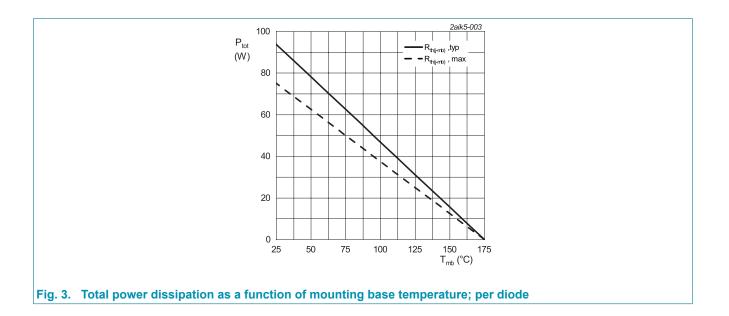


 $\begin{array}{l} I_{\text{F(AV)}} = I_{\text{F(RMS)}} \star \sqrt{\delta} \\ V_{\text{o}} = 1.144 \; \text{V}; \; \text{R}_{\text{s}} = 0.1272 \; \Omega \end{array}$ Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values; per diode



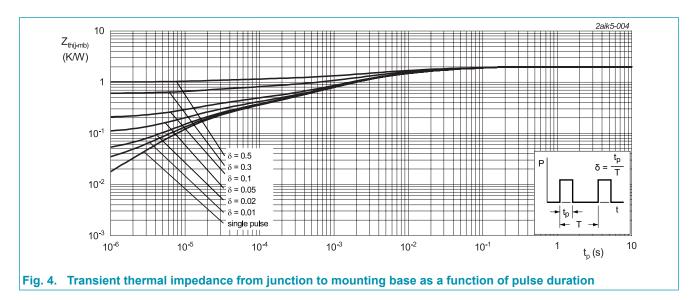


WNSC2D16650CW Silicon Carbide Diode



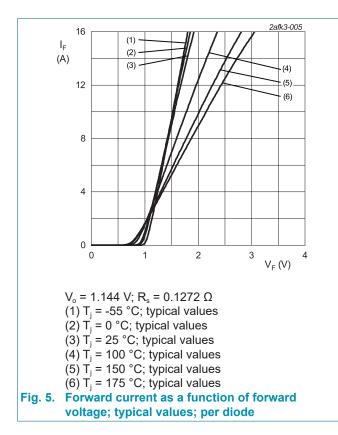
9. Thermal characteristics

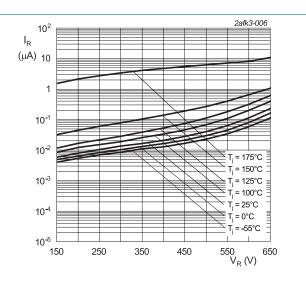
Table 6. Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance	per diode; <u>Fig. 4</u>		-	-	2	K/W
	from junction to mounting base	both diodes conducting		-	-	1	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air		-	40	-	K/W



10. Characteristics

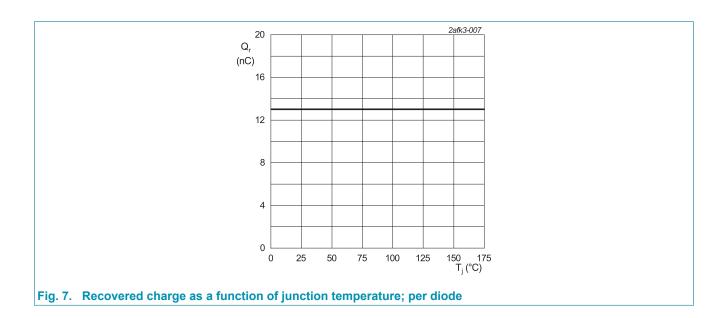
Table 7. Cl	haracteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V _F	forward current	$I_{F} = 8 \text{ A}; T_{j} = 25 \text{ °C}; \text{ per diode}; Fig. 5$	-	1.5	1.7	V
		I _F = 8 A; T _j = 150 °C; per diode; <u>Fig. 5</u>	-	1.8	2.2	V
		I _F = 8 A; T _j = 175 °C; per diode; <u>Fig. 5</u>	-	2	2.3	V
I _R	reverse current	V_{R} = 650 V; T _j = 25 °C; per diode; <u>Fig. 6</u>	-	0.4	40	μA
		V_{R} = 650 V; T _j = 175 °C; per diode; <u>Fig. 6</u>	-	20	200	μA
Dynamic	characteristics					
Q _r	recovered charge	$I_F = 8 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ per diode}; Fig. 7$	-	13	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C	-	260	-	pF
		f = 1 MHz; V _R = 300 V; T _j = 25 °C	-	31	-	pF
		f = 1 MHz; V _R = 600 V; T _j = 25 °C	-	27	-	pF
E _{as}	non-repetitive avalanche energy	$I_R = 4.9 \text{ A}; \text{ L} = 5 \text{ mH}; T_{j(init)} = 25 \text{ °C};$ per diode	60	-	-	mJ



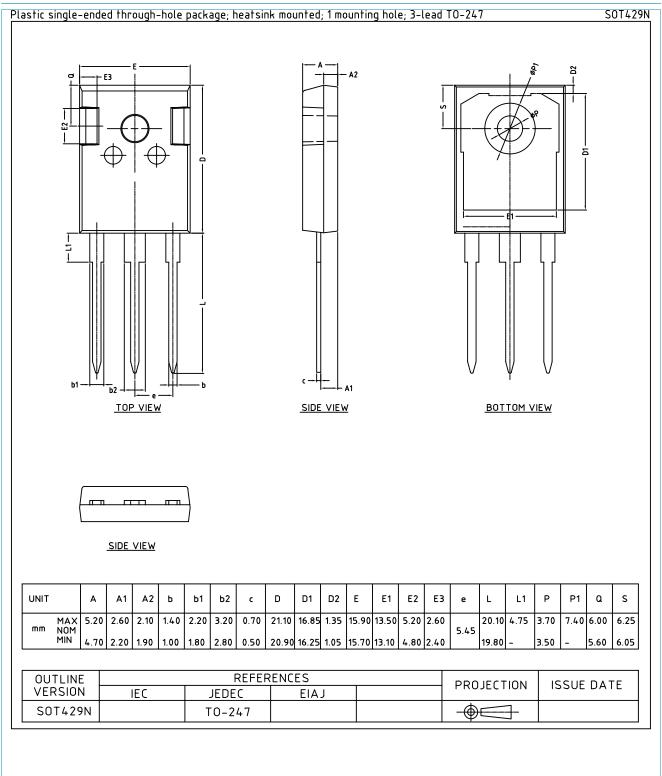




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11. Package outline



WNSC2D16650CW

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.ween-semi.com</u>.

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